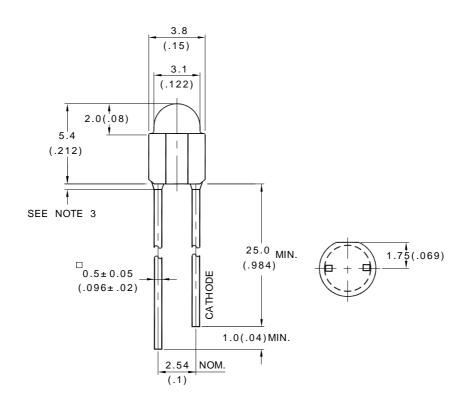
Property of Lite-On Only

Features

- * Lead (Pb) free product RoHS compliant.
- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on P.C. Board or panel.
- * I.C. Compatible/low current requirement.
- * Popular T-1 diameter package.



Package Dimensions



Part No.	Lens	Source Color
LTL17KFL5D-012A	Amber Diffused	AlInGaP Amber

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

Part No.: LTL17KFL5D-012A	Page:	1	of	11	

Property of Lite-On Only

Absolute Maximum Ratings at TA=25°C

Parameter	Maximum Rating	Unit
Power Dissipation	75	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	60	mA
DC Forward Current	30	mA
Derating Linear From 50°C	0.66	mA/°C
Reverse Voltage	5	V
Operating Temperature Range	-40°C to + 80°C	
Storage Temperature Range	-55°C to + 100°C	
Lead Soldering Temperature [1.6 mm(.063") From Body]	260°C for 5 Seconds Max.	

Part No.: LTL17KFL5D-012A Page: 2 of 11



Property of Lite-On Only

Electrical / Optical Characteristics at $T_A=25^{\circ}C$

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	140	400	680	mcd	I _F = 20mA Note 1
Viewing Angle	201/2	1	50	1	deg	Note 2 (Fig.5)
Peak Emission Wavelength	λР	1	611	ı	nm	Measurement @Peak (Fig.1)
Dominant Wavelength	$\lambda_{ m d}$	600	605	613.5	nm	Note 4
Spectral Line Half-Width	Δλ	-	17	-	nm	
Forward Voltage	V_{F}	1	2.05	2.4	V	$I_F = 20 \text{mA}$
Reverse Current	I_R	1	-	100	μΑ	$V_R = 5V$
Capacitance	С	-	40	-	pF	V _F = 0 , f = 1MHz

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Part No.: LTL17KFL5D-012A Page: 3 of 11 Property of Lite-On Only

Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

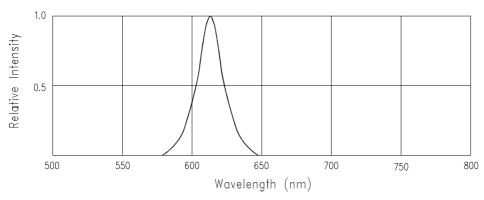


Fig.1 Relative Intensity v.s Wavelength

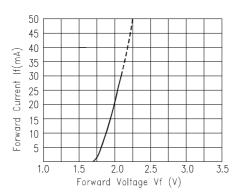


Fig.2 Forward Current v.s Forward Voltage

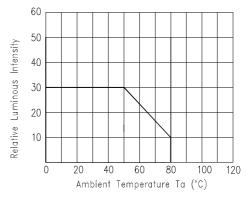


Fig.3 Forward Current v.s Ambient Temperature

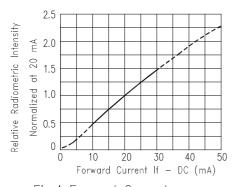


Fig.4 Forward Current v.s Radiometric Intensity

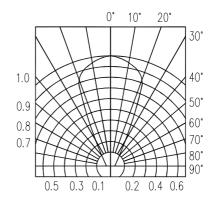


Fig.5 Spatial Distribution

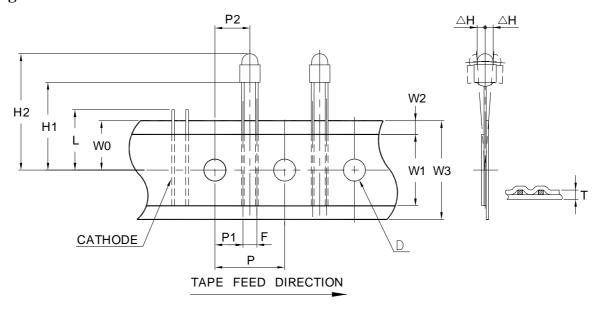
Part No.: LTL17KFL5D-012A Page: 4 of 11

Property of Lite-On Only

Features

- * Compatible with radial lead automatic insertion equipment.
- * Most radial lead plastic lead lamps available packaged in tape and folding.
- * 2.54mm (0.1") straight lead spacing available.
- * Folding packaging simplifies handling and testing.

Package Dimensions



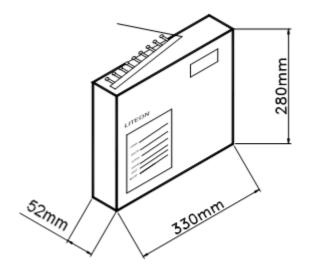
		Specification				
Item	Symbol	Minimum		Maximum		
		mm	inch	mm	inch	
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165	
Component Lead Pitch	F	2.3	0.091	3.0	0.118	
Front to Rear Deflection	ΔН			2.0	0.078	
Feed Hole to Bottom of Component	H1	21.5	0.846	22.5	0.886	
Feed Hole to Overall Component Height	H2	26.5	1.041	28.5	1.120	
Lead Length After Component Height	L	W0		11.0	0.433	
Feed Hole Pitch	P	12.4	0.488	13.0	0.511	
Lead Location	P1	4.4	0.173	5.8	0.228	
Center of Component Location	P2	5.05	0.198	7.65	0.301	
Total Tape Thickness	T			0.90	0.035	
Feed Hole Location	W0	8.5	0.334	9.75	0.384	
Adhesive Tape Width	W1	14.5	0.571	15.5	0.610	
Adhesive Tape Position	W2	0	0	3.0	0.118	
Tape Width	W3	17.5	0.689	19.0	0.748	

Part No.: LTL17KFL5D-012A	Page:	5	of	11
---------------------------	-------	---	----	----

Property of Lite-On Only

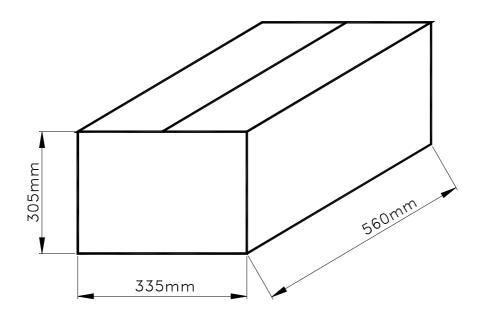
Packing Spec

3,000 pcs per inner carton



Tolerance: ±5mm

10 Inner cartons per outer carton, total 30,000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing



Part No.: LTL17KFL5D-012A Page: 6 of 11



Property of Lite-On Only

Bin Table Specification

Luminous Inte	ensity Unit	: mcd @20mA
Bin Code	Min.	Max.
GH	140	240
JK	240	400
LM	400	680

Note: Tolerance of each bin limit is $\pm 15\%$

Dominant Wavelength		t : nm @20mA
Bin Code	Min.	Max.
H23	600.0	603.0
H24	603.0	606.5
H25	606.5	610.0
H26	610.0	613.5

Note: Tolerance of each bin limit is ±1nm

Part No.: LTL17KFL5D-012A Page: of 11



Property of Lite-On Only

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity.

It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 1.6mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, For Lamp without stopper type and must be leave a minimum of 1.6mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering iron		Wave soldering		
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	120°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED

Part No.: LTL17KFL5D-012A Page: of 11

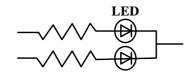
Property of Lite-On Only

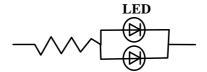
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A

Circuit model B





- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

ESD-damaged Leeds will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light up" at low currents. To verify for ESD damage, check for "light up" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

Chip ESD level	Machine Model	Human Body Model
InGaN / Sapphire	100 V	300 V
AlInGaP	200 V	500 V
InGaN / SiC	600 V	1000 V

Part No.: LTL17KFL5D-012A Page: 9 of 11

Property of Lite-On Only

Suggested checking list:

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DSL?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Part No.: LTL17KFL5D-012A Page: 10 of 11



Property of Lite-On Only

8. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under room temperature as per data sheet maximum rating. *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
Endurance	High Temperature High Humidity Storage	Ta= 65±5°C RH= 90 ∼ 95% Test Time= 240HRS±2HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)
Test High Temperature Storage		Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)
	Temperature Cycling	105°C ~ 25°C ~ -55°C ~ 25°C 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)
Environmental	Thermal Shock	105 ± 5°C ~ -55°C ± 5°C 10mins 10 mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
Test	Solder Resistance	T.sol = 260 °C Max. Dwell Time= 5secs Max.	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)
	Solderability	T. sol = $230 \pm 5^{\circ}$ C Dwell Time= 5 ± 1 secs	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)

9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

Part No.: LTL17KFL5D-012A	Page:	11	of	11
---------------------------	-------	----	----	----